

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCN No.	ANALOG MEMS SENSORS/25/15595
1.3 Title of PCN	ST Manufacturing Reshaping (MEMS 5): Qualification of ROUSSET (FRANCE) for ASIC as new FE location and CROLLES (FRANCE) for ASIC and MEMS as new EWS Location.
1.4 Product Category	Pls Refer to the Impacted Products List.
1.5 Issue date	2025-07-24

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Simone FERRI
2.1.2 Marketing Manager	Tarik SOUBES
2.1.3 Quality Manager	Fabio BIGANZOLI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Manufacturing reshaping program	Manufacturing reshaping program	ASIC: ROUSSET (8") as Front End Plant ASIC: CROLLES as EWS Plant MEMS: CROLLES as EWS Plan

4. Description of change

	Old	New
4.1 Description	ASIC : CR200 (8") as Front End Plant ASIC: Catania (Italy) as EWS Plant MEMS: Agrate (Italy) as EWS Plant	ASIC: ROUSSET (8") as Front End Plant ASIC: CROLLES as EWS Plant MEMS: CROLLES as EWS Plant
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact. The products guarantee the same quality and electrical characteristics as per current production.	

5. Reason / motivation for change

5.1 Motivation	In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase production Capacity, ST Microelectronics is announcing the qualification of ROUSSET (FRANCE) for ASIC as new FE location and CROLLES (FRANCE) for ASIC and MEMS as new EWS Location. Please be advised that the enclosed list of products and dates could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available. SCHEDULING COMMENT: Below schedule of qualification report availability and intended start of delivery refer to first product qualification.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability of change will be ensured by an internal codification
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7. Timing / schedule

7.1 Date of qualification results	2027-01-22
7.2 Intended start of delivery	2027-07-23
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	
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8.2 Qualification report and qualification results	In progress	Issue Date	
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9. Attachments (additional documentations)
15595 Public product.pdf 15595 PCN MEMS_5.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	AIS328DQTR	
	H3LIS100DLTR	
	H3LIS200DLTR	
	H3LIS331DLTR	
	IIS328DQTR	
	LIS331DLHTR	

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